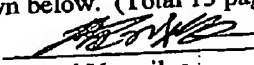


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## Certificate of Facsimile Transmission

I hereby certify that the attached Transmittal (1 page) and Response to the Office Action dated October 12, 2005 (12 pages), are submitted to the U.S. Patent and Trademark Office via facsimile number (571) 273-8300 on the date shown below. (Total 13 pages).

  
 Li Mei Vermilya

Date: January 12, 2006

 PATENT APPLICATION  
 Docket No.: 9903-078  
 Client Ref. No.: S02US013D

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Young-Hee SONG, et al.

Serial No.: 10/651,813

Examiner:

Williams, Alexander O.

Filed: August 28, 2003

Group Art Unit: 2826

Confirmation No.: 9556

 For: SEMICONDUCTOR CHIP HAVING BOND PADS AND MULTI-CHIP  
 PACKAGE

 Mail Stop Amendment  
 Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Responsive to the Office Action dated October 12, 2005, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	28	30	0	x \$50 =	\$0
Independent Claims	4	5	0	x \$200 =	\$0
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0

\*greater of twenty (20) or number for which fee has been paid

\*\*greater of three (3) or number for which fee has been paid

☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

 Respectfully submitted,  
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AMENDMENT

Responsive to the Office Action, Paper No. 20051003, dated October 12, 2005, please  
amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on  
page 2 of this paper.

Remarks begin on page 7 of this paper.